

HSF

NOTES:

Current Rating: 1.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: -40℃ to +105℃

Contact Material: Phosphor Bronze
Contact plating: Au Or Sn over Ni
Insulator Material: PA9T+30%GF UL94V-0

Ordering Information

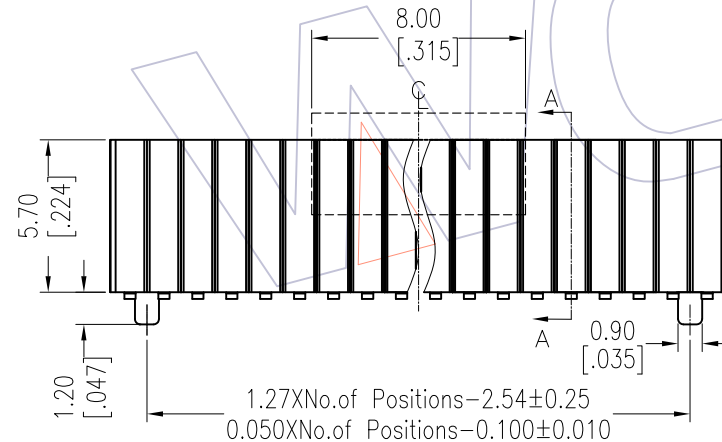
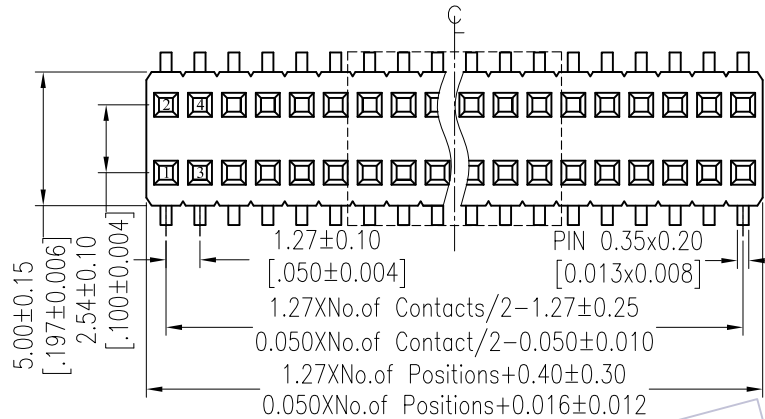
2457-2 XX M XX CUN T X

No. of Pins per
Row: 02~50Pin

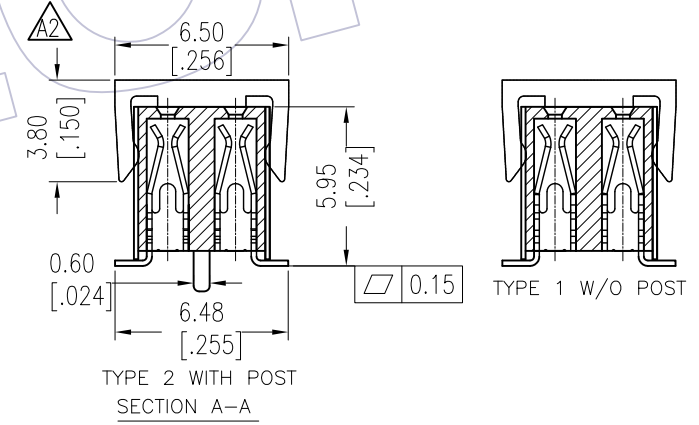
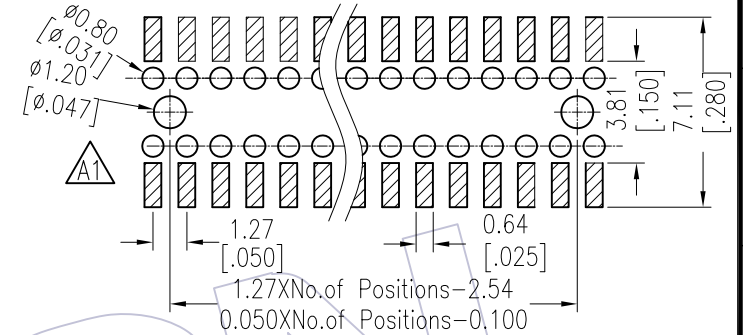
Contact Plating:
G0=Gold Flash
G3=10μ"Gold
G4=15μ"Gold
G5=30μ"Gold
S0=Gold Flash/Tin
S3=10μ"Gold/Tin
S4=15μ"Gold/Tin
S5=30μ"Gold/Tin
SN=Tin

Packing:
T=Tube
P=Tube+CAP
R=Tape&Reel+CAP

Series No.
1=Type 1
2=Type 2



Recommended P.C.B Layout(Top Side) (PCB BOARD TOLERANCE±0.05)



Item	Pitch	Mating
Standard	1.27*2.54	1417/1425
Alternate		



TITLE	PART NO.
TYPE 1	2457-2XXMXXCUNT1
TYPE 2	2457-2XXMXXCUNT2

OPERATION			DRAW		DATE	SCALE	FIT	PART NO.	SEE TABLE	
A2	2013/06/17	Modify CAP 4.30 → 3.80	X.X	±0.40						
A1	2012/11/09	Modificated P.C.B Layout and the left table	X.XX	±0.25	DATE	SIZE	A4	TITLE:	FH1.27X2.54 DUAL Row 180° SMT H=5.7	
A0	2012/07/10	NEW	X.XXX	±0.15						
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle	± 3°	APPROVE	DATE	SHEET	1/1	Customer NO.
				DIM	TOL			PROJ.		